AUTOMOTIVE

RoHS

COMPLIANT

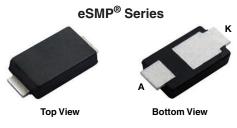
HALOGEN

FREE



# Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



**SMPA (DO-221BC)** 



### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	8.0 A		
V <sub>RRM</sub>	200 V		
I <sub>FSM</sub>	100 A		
V <sub>F</sub> at I <sub>F</sub> = 8.0 A (T <sub>A</sub> = 125 °C)	0.70 V		
T <sub>J</sub> max.	175 °C		
Package	SMPA (DO-221BC)		
Circuit configuration	Single		

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8PA22	UNIT	
Device marking code		V822		
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	V	
Maximum DC forward current	I <sub>F(AV)</sub> (1)	8.0	A	
Maximum DC forward current	I <sub>F(AV)</sub> (2)	2.4		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	100	А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	T <sub>J</sub> <sup>(3)</sup> -40 to +175		
Storage temperature range	T <sub>STG</sub>	-40 to +175	°C	

#### Notes

- (1) Mounted on 3 cm x 3 cm copper pad area PCB
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$



## www.vishay.com

# Vishay General Semiconductor

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	T <sub>A</sub> = 25 °C	V <sub>E</sub> (1)	0.77	-	V	
	$I_F = 8.0 A$			0.84	0.92		
	$I_F = 4.0 A$	T <sub>A</sub> = 125 °C		VF ('')	0.62	-	\ \ \
	I <sub>F</sub> = 8.0 A			0.70	0.78		
Reverse current	V <sub>R</sub> = 160 V	$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$	I <sub>R</sub> <sup>(2)</sup>	0.001	-	mA	
	V <sub>R</sub> = 160 V	T <sub>A</sub> = 125 °C		0.5	-		
	V = 200 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C		-	0.10		
	V <sub>R</sub> = 200 V	T <sub>A</sub> = 125 °C		1.0	7.0		
Typical junction capacitance	4.0 V, 1 MHz		CJ	400	-	pF	

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5 \text{ ms}$ 

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL	V8PA22	UNIT	
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	100	°C/W	
Typical thermal resistance	R <sub>0JM</sub> (3)	5		

#### **Notes**

- <sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- (2) Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  junction to ambient
- $^{(3)}$  Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance  $R_{\theta JM}$  junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PA22-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
V8PA22-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V8PA22HM3/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
V8PA22HM3/I <sup>(1)</sup>	0.032	I	14 000	13" diameter plastic tape and reel	

#### Note

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

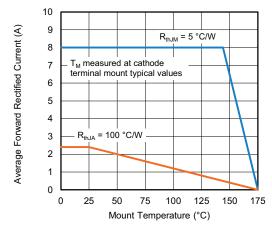


Fig. 1 - Maximum Forward Current Derating Curve

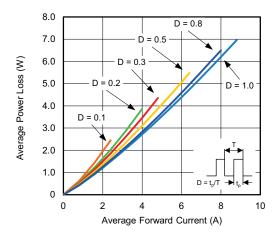


Fig. 2 - Forward Power Loss Characteristics

<sup>(1)</sup> AEC-Q101 qualified



## www.vishay.com

# Vishay General Semiconductor

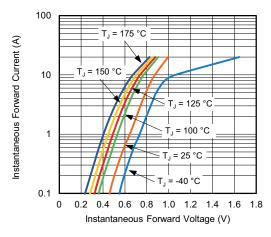


Fig. 3 - Typical Instantaneous Forward Characteristics

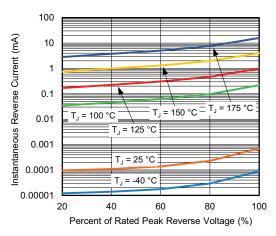


Fig. 4 - Typical Reverse Leakage Characteristics

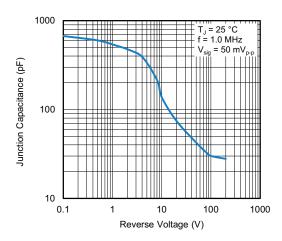


Fig. 5 - Typical Junction Capacitance

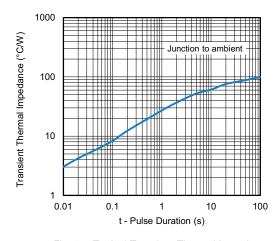


Fig. 6 - Typical Transient Thermal Impedance

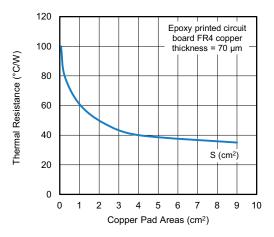


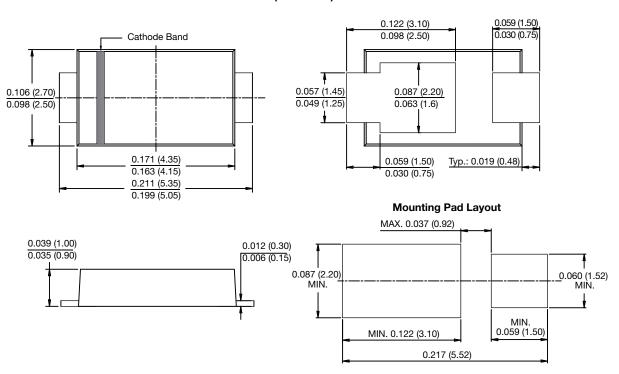
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



# Vishay General Semiconductor

## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMPA (DO-221BC)**





## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.